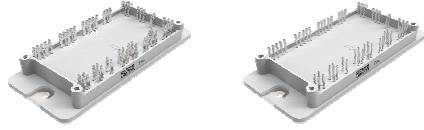
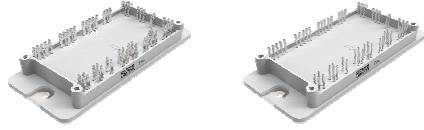
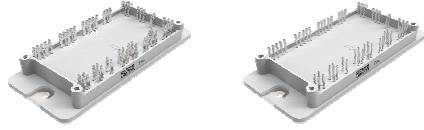
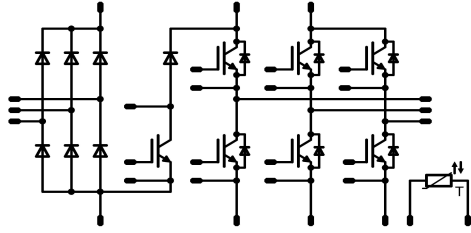
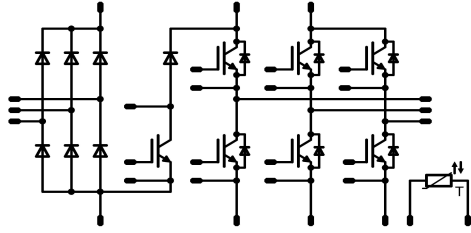
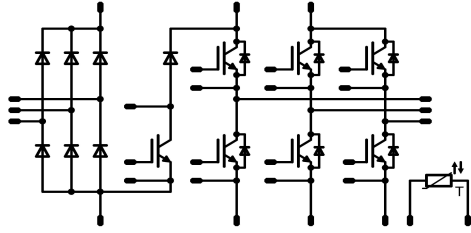




<i>flow</i> PIM 2 3rd	1200 V / 75 A				
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Maximum Ratings

$T_j=25^{\circ}\text{C}$, unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
Input Rectifier Diode				
Repetitive peak reverse voltage	V_{RRM}		1600	V
Forward current	I_{FAV}	DC current	$T_h=80^{\circ}\text{C}$ 100 $T_c=80^{\circ}\text{C}$ 100	A
Surge forward current	I_{FSM}	$t_p=10\text{ms}$	$T_j=25^{\circ}\text{C}$ 1000	A
I2t-value	I^2t		5000	A^2s
Power dissipation	P_{tot}	$T_j=T_{jmax}$	$T_h=80^{\circ}\text{C}$ 114 $T_c=80^{\circ}\text{C}$ 172	W
Maximum Junction Temperature	T_{jmax}		150	$^{\circ}\text{C}$
Inverter IGBT				
Collector-emitter break down voltage	V_{CE}		1200	V
DC collector current	I_C	$T_j=T_{jmax}$	$T_h=80^{\circ}\text{C}$ 80 $T_c=80^{\circ}\text{C}$ 100	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	210	A
Power dissipation	P_{tot}	$T_j=T_{jmax}$	$T_h=80^{\circ}\text{C}$ 211 $T_c=80^{\circ}\text{C}$ 319	W
Gate-emitter peak voltage	V_{GE}		± 20	V
Short circuit ratings	t_{SC} V_{CC}	$T_j \leq 150^{\circ}\text{C}$ $V_{GE} = 15\text{V}$	10 900	μs V
Maximum Junction Temperature	T_{jmax}		175	$^{\circ}\text{C}$



Maximum Ratings

$T_j=25^{\circ}\text{C}$, unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
-----------	--------	-----------	-------	------

Inverter FWD

Peak Repetitive Reverse Voltage	V_{RRM}		1200	V
DC forward current	I_F	$T_j=T_{jmax}$ $T_h=80^{\circ}\text{C}$ $T_c=80^{\circ}\text{C}$	73 97	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	150	A
Power dissipation	P_{tot}	$T_j=T_{jmax}$ $T_h=80^{\circ}\text{C}$ $T_c=80^{\circ}\text{C}$	135 205	W
Maximum Junction Temperature	T_{jmax}		175	$^{\circ}\text{C}$

Brake IGBT

Collector-emitter break down voltage	V_{CE}		1200	V
DC collector current	I_C	$T_j=T_{jmax}$ $T_h=80^{\circ}\text{C}$ $T_c=80^{\circ}\text{C}$	58 74	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	150	A
Power dissipation	P_{tot}	$T_j=T_{jmax}$ $T_h=80^{\circ}\text{C}$ $T_c=80^{\circ}\text{C}$	155 235	W
Gate-emitter peak voltage	V_{GE}		± 20	V
Short circuit ratings	t_{SC} V_{CC}	$T_j \leq 150^{\circ}\text{C}$ $V_{GE} = 15\text{V}$	10 900	μs V
Maximum Junction Temperature	T_{jmax}		175	$^{\circ}\text{C}$

Brake Inverse Diode

Peak Repetitive Reverse Voltage	V_{RRM}		1200	V
DC forward current	I_F	$T_j=T_{jmax}$ $T_h=80^{\circ}\text{C}$ $T_c=80^{\circ}\text{C}$	16 16	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	20	A
Brake Inverse Diode	P_{tot}	$T_j=T_{jmax}$ $T_h=80^{\circ}\text{C}$ $T_c=80^{\circ}\text{C}$	50 75	W
Maximum Junction Temperature	T_{jmax}		175	$^{\circ}\text{C}$

Brake FWD

Peak Repetitive Reverse Voltage	V_{RRM}		1200	V
DC forward current	I_F	$T_j=T_{jmax}$ $T_h=80^{\circ}\text{C}$ $T_c=80^{\circ}\text{C}$	35 40	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	50	A
Power dissipation	P_{tot}	$T_j=T_{jmax}$ $T_h=80^{\circ}\text{C}$ $T_c=80^{\circ}\text{C}$	75 114	W
Maximum Junction Temperature	T_{jmax}		175	$^{\circ}\text{C}$



Maximum Ratings

$T_j=25^{\circ}\text{C}$, unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
-----------	--------	-----------	-------	------

Thermal properties

Storage temperature	T_{stg}		-40...+125	$^{\circ}\text{C}$
Operation temperature under switching condition	T_{op}		-40...+T _{jmax} -25	$^{\circ}\text{C}$

Insulation properties

Insulation voltage	V_{is}	t=1min	4000	V_{DC}
Creepage distance			min 12,7	mm
Clearance			min 12,7	mm

Characteristic Values

Parameter	Symbol	Conditions				Value			Unit
		V_{GE} [V] or V_{GS} [V]	V_F [V] or V_{CE} [V] or V_{DS} [V]	I_C [A] or I_F [A] or I_D [A]	T_j	Min	Typ	Max	

Input Rectifier Diode

Forward voltage	V_F				100	$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$	1,18 1,16	1,9	V
Threshold voltage (for power loss calc. only)	V_{to}					$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$	0,87 0,79		V
Slope resistance (for power loss calc. only)	r_t					$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$	0,003 0,004		Ω
Reverse current	I_r			1500		$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$		0,05 1,1	mA
Thermal resistance chip to heatsink	23990-P769	Thermal grease thickness $\leq 50\mu\text{m}$						0,61	K/W
Thermal resistance chip to case	23990-P769	$\lambda = 0,61 \text{ W/m}\cdot\text{K}$						0,40	

Inverter IGBT

Gate emitter threshold voltage	$V_{GE(th)}$	$V_{CE}=V_{GE}$			0,0024	$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$	5	5,8	6,5	V
Collector-emitter saturation voltage	V_{CESat}		15		75	$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$		1,96 2,47	2,1	V
Collector-emitter cut-off current incl. Diode	I_{CES}		0	1200		$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$			0,025	mA
Gate-emitter leakage current	I_{GES}		20	0		$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$			200	nA
Integrated Gate resistor	R_{gint}							none		Ω
Turn-on delay time	$t_{d(on)}$	$R_{goff}=8 \Omega$ $R_{gon}=8 \Omega$	± 15	600	75	$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$		106 86	ns	
Rise time	t_r					$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$		24 23		
Turn-off delay time	$t_{d(off)}$					$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$		188 270		
Fall time	t_f					$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$		64,9 114		
Turn-on energy loss per pulse	E_{on}					$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$		3,97 6,39		mWs
Turn-off energy loss per pulse	E_{off}	$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$		3,63 6,39						
Input capacitance	C_{ies}							3900	pF	
Output capacitance	C_{oss}	$f=1\text{MHz}$	0	25		$T_j=25^\circ\text{C}$		310		
Reverse transfer capacitance	C_{rss}							230		
Gate charge	Q_g		± 15			$T_j=25^\circ\text{C}$		400	nC	
Thermal resistance chip to heatsink	$R_{th(j-s)}$							0,45	K/W	
Thermal resistance chip to case	$R_{th(j-c)}$	Thermal grease thickness $\leq 50\mu\text{m}$						0,3		
Coupled thermal resistance transistor-transistor	$R_{th(jj)T-T}$	$\lambda = 0,61 \text{ W/m}\cdot\text{K}$						0,09		
Coupled thermal resistance diode-transistor	$R_{th(jj)D-T}$							0,1		

Inverter FWD

Diode forward voltage	V_F				75	$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$		1,81 1,83	2,4	V
Peak reverse recovery current	I_{RRM}					$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$		46,6 117		A
Reverse recovery time	t_{rr}	$R_{gon}=8 \Omega$	± 15	600	75	$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$		287 310	ns	
Reverse recovered charge	Q_{rr}					$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$		4,17 14,13		
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$		2312 1378		A/ μs
Reverse recovered energy	E_{rec}					$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$		1,78 5,64		
Thermal resistance chip to heatsink	$R_{th(j-s)}$									
Thermal resistance chip to case	$R_{th(j-c)}$	Thermal grease thickness $\leq 50\mu\text{m}$						0,46		
Coupled thermal resistance transistor-diode	$R_{th(jj)T-D}$	$\lambda = 0,61 \text{ W/m}\cdot\text{K}$						0,08		

Characteristic Values

Parameter	Symbol	Conditions					Value			Unit
		V_{GE} [V] or V_{GS} [V]	V_r [V] or V_{CE} [V] or V_{DS} [V]	I_c [A] or I_F [A] or I_D [A]	T_j	Min	Typ	Max		
Brake IGBT										
Gate emitter threshold voltage	$V_{GE(th)}$	$V_{CE}=V_{GE}$			0,0017	$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$	5	5,8	6,5	V
Collector-emitter saturation voltage	V_{CEsat}		15		50	$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$		1,9 2,3	2,3	V
Collector-emitter cut-off incl diode	I_{CES}		0	1200		$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$			0,25	mA
Gate-emitter leakage current	I_{GES}		20	0		$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$			200	nA
Integrated Gate resistor	R_{gint}							4		Ω
Turn-on delay time	$t_{d(on)}$	Rgoff=8 Ω Rgon=8 Ω	± 15	600	50	$T_j=25^\circ\text{C}$		98		ns
Rise time	t_r					$T_j=150^\circ\text{C}$		103		
Turn-off delay time	$t_{d(off)}$					$T_j=25^\circ\text{C}$		18		
Fall time	t_f					$T_j=150^\circ\text{C}$		25		
Turn-on energy loss per pulse	E_{on}					$T_j=25^\circ\text{C}$		208		
Turn-off energy loss per pulse	E_{off}					$T_j=150^\circ\text{C}$		284		
Input capacitance	C_{ies}					$T_j=25^\circ\text{C}$		2770		pF
Output capacitance	C_{oss}	f=1MHz	0	25				205		
Reverse transfer capacitance	C_{rss}							160		
Gate charge	Q_G		± 15	960		$T_j=25^\circ\text{C}$		290		nC
Thermal resistance chip to heatsink	$R_{th(j-s)}$	Thermal grease thickness $\leq 50\mu\text{m}$ $\lambda = 0,61 \text{ W/m}\cdot\text{K}$						0,61		K/W
Thermal resistance chip to case	$R_{th(j-c)}$							0,40		
Brake Inverse Diode										
Diode forward voltage	V_F				10	$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$	1,1	1,81 1,81	2,1	V
Thermal resistance chip to heatsink	$R_{th(j-s)}$	Thermal grease thickness $\leq 50\mu\text{m}$ $\lambda = 0,61 \text{ W/m}\cdot\text{K}$						1,92		K/W
Thermal resistance chip to case	$R_{th(j-c)}$							1,27		K/W
Brake FWD										
Diode forward voltage	V_F				25	$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$		1,82 1,82	2,2	V
Reverse leakage current	I_r		± 15	600	50	$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$			10	μA
Peak reverse recovery current	I_{RRM}	Rgon=8 Ω	± 15	600	50	$T_j=25^\circ\text{C}$		51		A
Reverse recovery time	t_{rr}					$T_j=150^\circ\text{C}$		51,67		
Reverse recovered charge	Q_{rr}					$T_j=25^\circ\text{C}$		152		
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					$T_j=150^\circ\text{C}$		328		
Reverse recovery energy	E_{rec}					$T_j=25^\circ\text{C}$		3,07		
						$T_j=150^\circ\text{C}$		6,3		
Thermal resistance chip to heatsink	$R_{th(j-s)}$	Thermal grease thickness $\leq 50\mu\text{m}$ $\lambda = 0,61 \text{ W/m}\cdot\text{K}$						1,27		K/W
Thermal resistance chip to case	$R_{th(j-c)}$							0,84		
Thermistor										
Rated resistance	R_{25}	Tol. $\pm 5\%$				$T_j=25^\circ\text{C}$		22		k Ω
Deviation of R100	$D_{R/R}$	R100=1486 Ω				$T_c=100^\circ\text{C}$	-12		12	%/K
Power dissipation	P					$T_j=25^\circ\text{C}$		200		mW
Power dissipation constant						$T_j=25^\circ\text{C}$		2		mW/K
B-value	$B_{(25/50)}$	Tol. $\pm 3\%$				$T_j=25^\circ\text{C}$		3950		K
B-value	$B_{(25/100)}$	Tol. $\pm 3\%$				$T_j=25^\circ\text{C}$		3998		K
Vincotech NTC Reference									B	

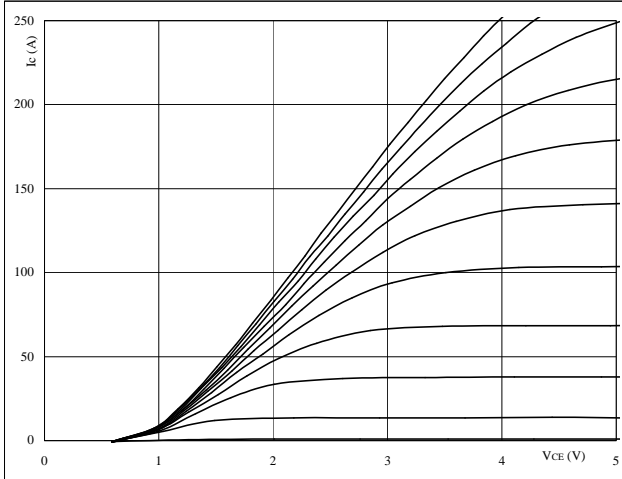


Output Inverter

Figure 1 Output inverter IGBT

Typical output characteristics

$I_C = f(V_{CE})$

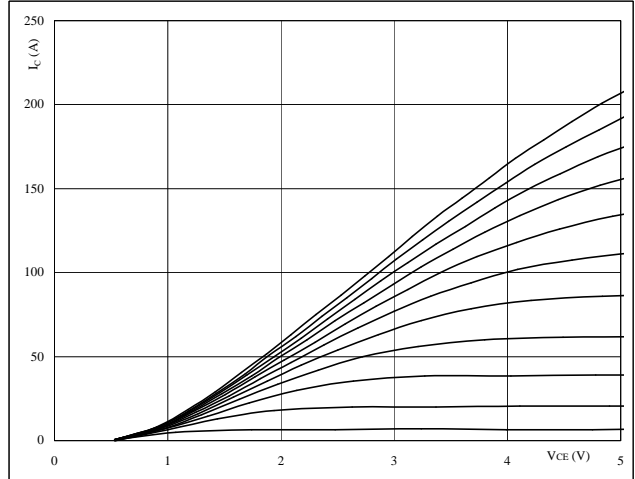


At
 $t_p = 250 \mu s$
 $T_j = 25 \text{ }^\circ C$
VGE from 7 V to 17 V in steps of 1 V

Figure 2 Output inverter IGBT

Typical output characteristics

$I_C = f(V_{CE})$

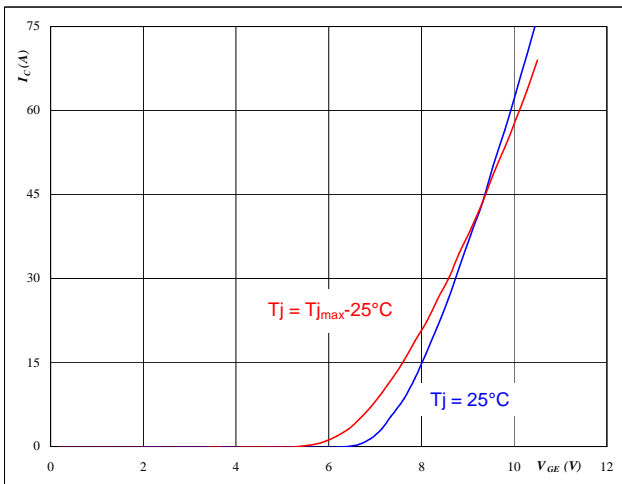


At
 $t_p = 250 \mu s$
 $T_j = 150 \text{ }^\circ C$
VGE from 7 V to 17 V in steps of 1 V

Figure 3 Output inverter IGBT

Typical transfer characteristics

$I_C = f(V_{GE})$

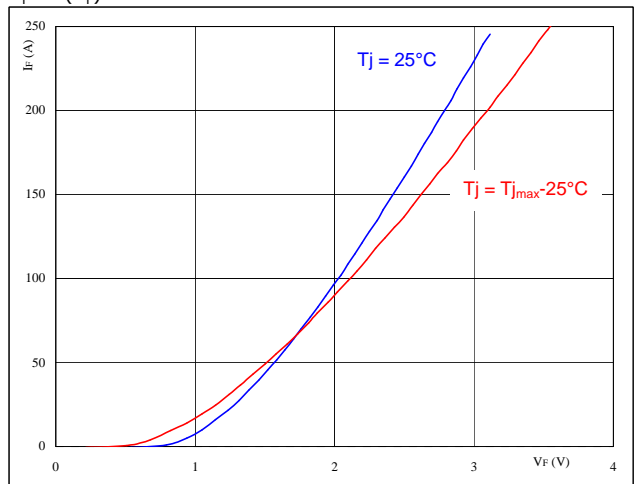


At
 $t_p = 250 \mu s$
 $V_{CE} = 10 V$

Figure 4 Output inverter FWD

Typical diode forward current as a function of forward voltage

$I_F = f(V_F)$



At
 $t_p = 250 \mu s$

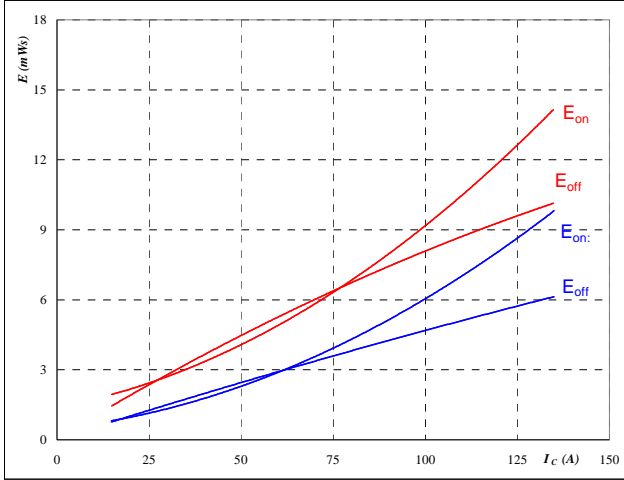


Output Inverter

Figure 5 Output inverter IGBT

Typical switching energy losses as a function of collector current

$E = f(I_C)$



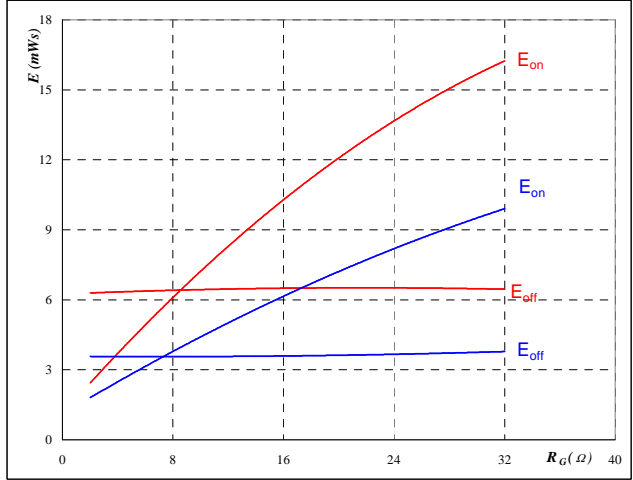
With an inductive load at

- T_j = 25/150 °C
- V_{CE} = 600 V
- V_{GE} = ±15 V
- R_{gon} = 8 Ω
- R_{goff} = 8 Ω

Figure 6 Output inverter IGBT

Typical switching energy losses as a function of gate resistor

$E = f(R_G)$



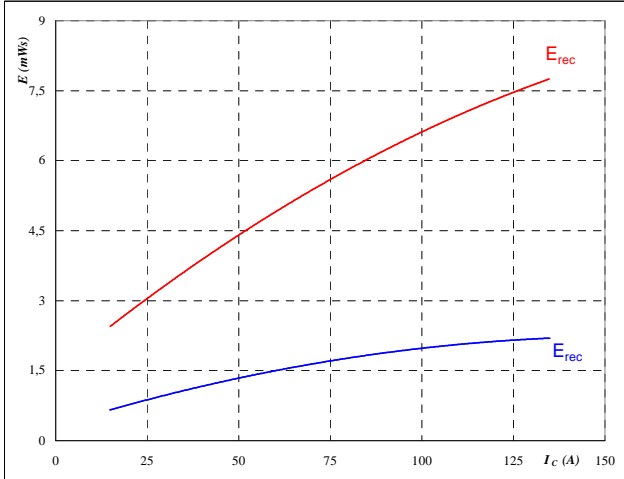
With an inductive load at

- T_j = 25/150 °C
- V_{CE} = 600 V
- V_{GE} = ±15 V
- I_C = 75 A

Figure 7 Output inverter IGBT

Typical reverse recovery energy loss as a function of collector current

$E_{rec} = f(I_C)$



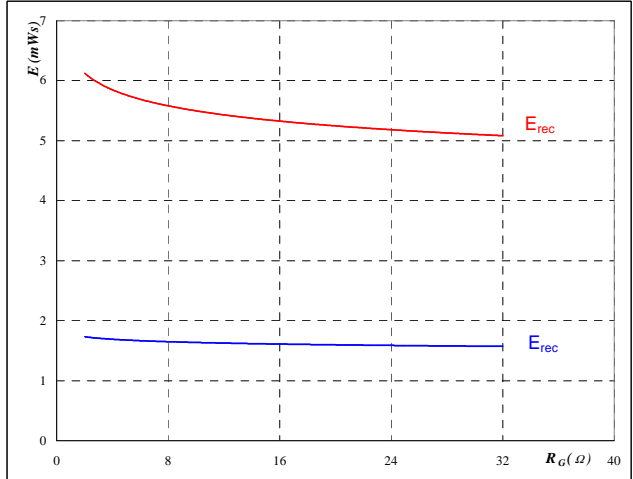
With an inductive load at

- T_j = 25/150 °C
- V_{CE} = 600 V
- V_{GE} = ±15 V
- R_{gon} = 8 Ω

Figure 8 Output inverter IGBT

Typical reverse recovery energy loss as a function of gate resistor

$E_{rec} = f(R_G)$



With an inductive load at

- T_j = 25/150 °C
- V_{CE} = 600 V
- V_{GE} = ±15 V
- I_C = 75 A

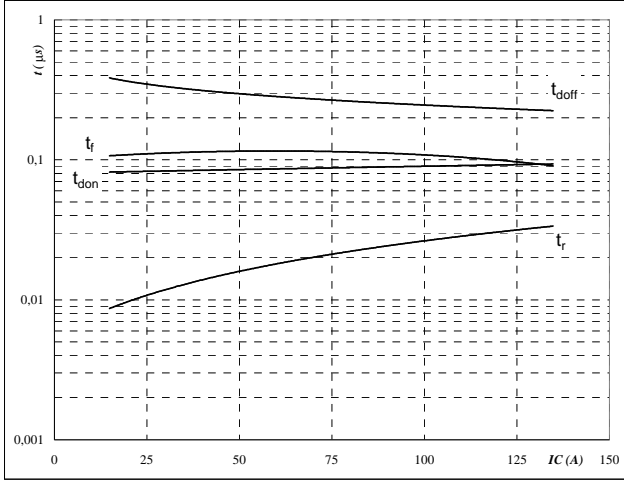


Output Inverter

Figure 9 Output inverter IGBT

Typical switching times as a function of collector current

$t = f(I_C)$



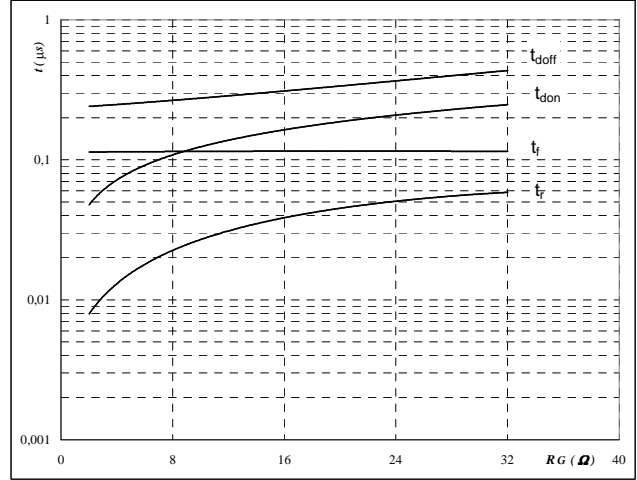
With an inductive load at

- $T_j = 150$ °C
- $V_{CE} = 600$ V
- $V_{GE} = \pm 15$ V
- $R_{gon} = 8$ Ω
- $R_{goff} = 8$ Ω

Figure 10 Output inverter IGBT

Typical switching times as a function of gate resistor

$t = f(R_G)$



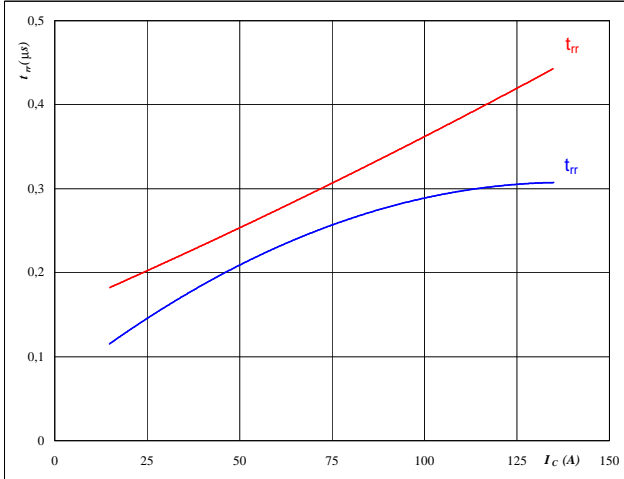
With an inductive load at

- $T_j = 150$ °C
- $V_{CE} = 600$ V
- $V_{GE} = \pm 15$ V
- $I_C = 75$ A

Figure 11 Output inverter FWD

Typical reverse recovery time as a function of collector current

$t_{rr} = f(I_C)$



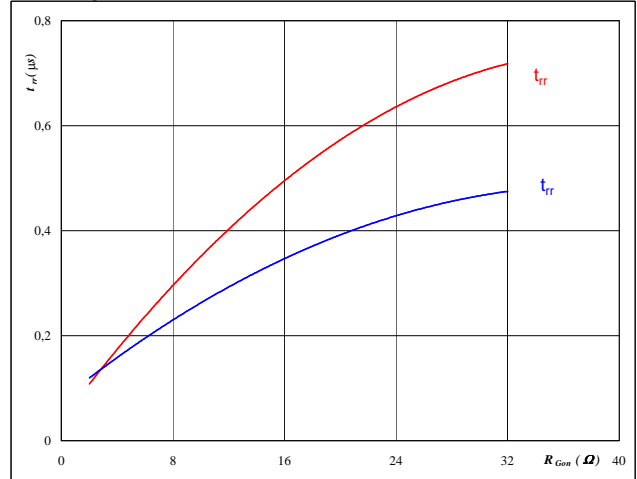
At

- $T_j = 25/150$ °C
- $V_{CE} = 600$ V
- $V_{GE} = \pm 15$ V
- $R_{gon} = 8$ Ω

Figure 12 Output inverter FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor

$t_{rr} = f(R_{gon})$



At

- $T_j = 25/150$ °C
- $V_R = 600$ V
- $I_F = 75$ A
- $V_{GE} = \pm 15$ V

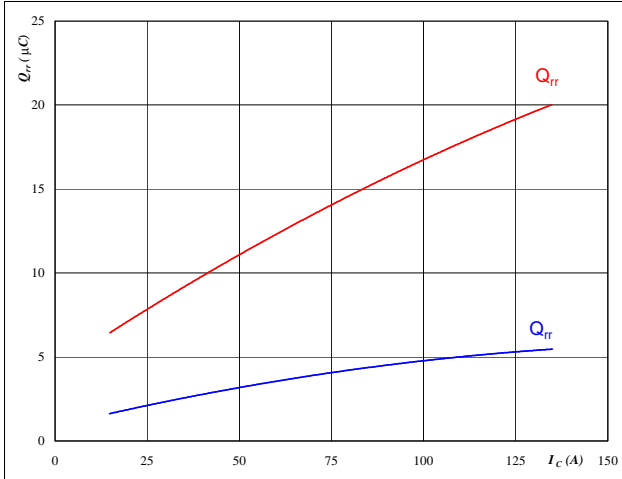


Output Inverter

Figure 13 Output inverter FWD

Typical reverse recovery charge as a function of collector current

$Q_{rr} = f(I_c)$

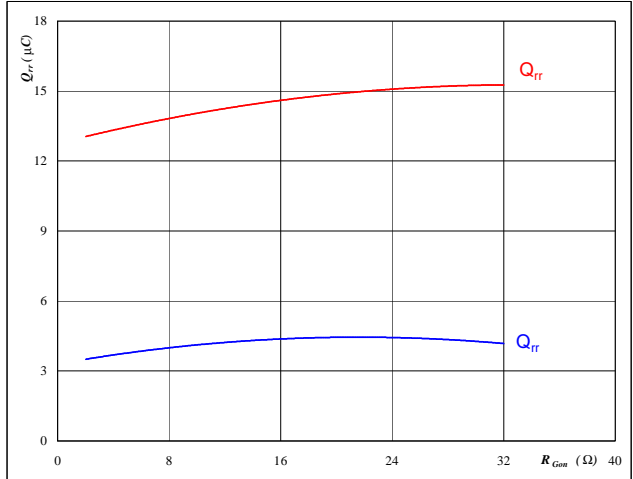


At
 $T_j = 25/150$ °C
 $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 8$ Ω

Figure 14 Output inverter FWD

Typical reverse recovery charge as a function of IGBT turn on gate resistor

$Q_{rr} = f(R_{gon})$

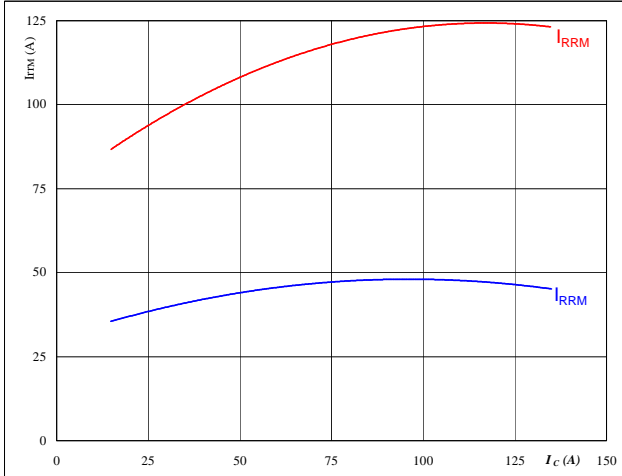


At
 $T_j = 25/150$ °C
 $V_R = 600$ V
 $I_F = 75$ A
 $V_{GE} = \pm 15$ V

Figure 15 Output inverter FWD

Typical reverse recovery current as a function of collector current

$I_{RRM} = f(I_c)$

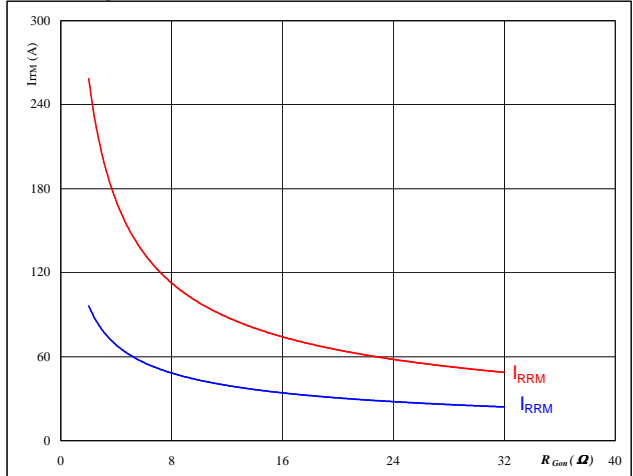


At
 $T_j = 25/150$ °C
 $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 8$ Ω

Figure 16 Output inverter FWD

Typical reverse recovery current as a function of IGBT turn on gate resistor

$I_{RRM} = f(R_{gon})$



At
 $T_j = 25/150$ °C
 $V_R = 600$ V
 $I_F = 75$ A
 $V_{GE} = \pm 15$ V

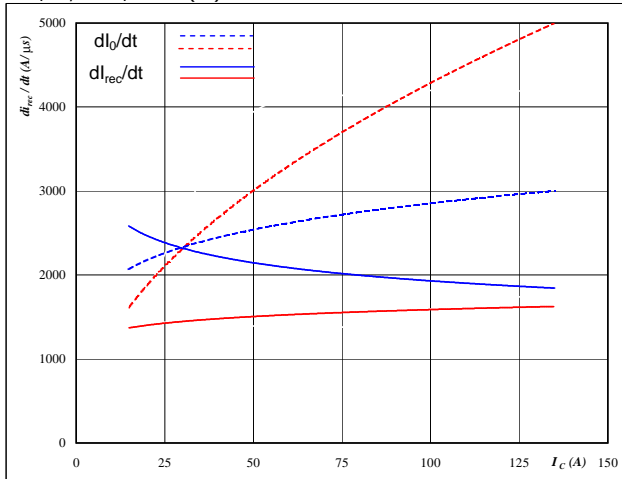


Output Inverter

Figure 17 Output inverter FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current

$dI_0/dt, dI_{rec}/dt = f(I_C)$

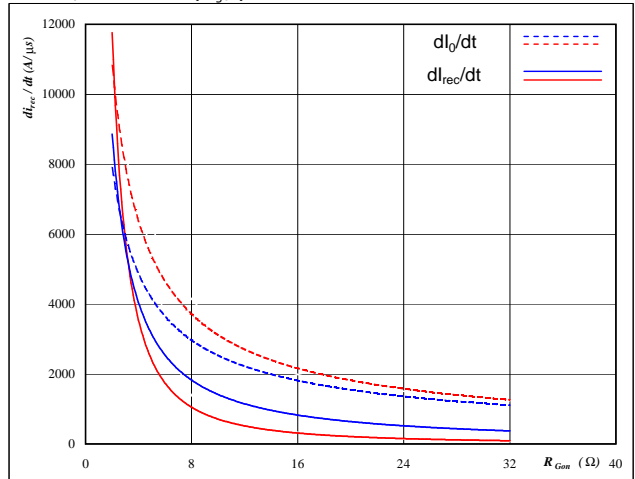


At
 $T_j = 25/150$ °C
 $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 8$ Ω

Figure 18 Output inverter FWD

Typical rate of fall of forward and reverse recovery current as a function of IGBT turn on gate resistor

$dI_0/dt, dI_{rec}/dt = f(R_{gon})$

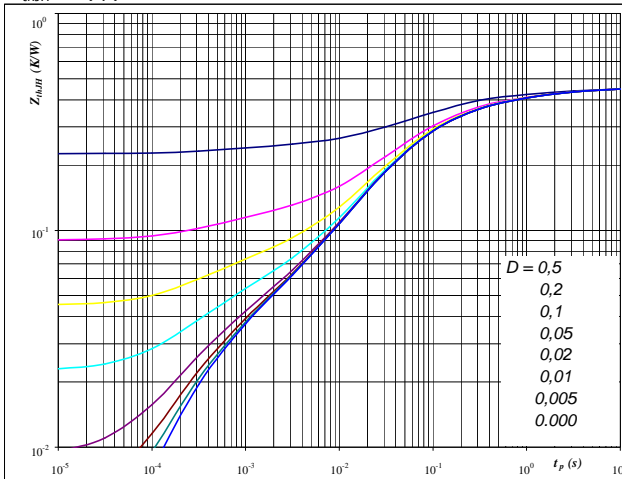


At
 $T_j = 25/150$ °C
 $V_R = 600$ V
 $I_F = 75$ A
 $V_{GE} = \pm 15$ V

Figure 19 Output inverter IGBT

IGBT transient thermal impedance as a function of pulse width

$Z_{thJH} = f(tp)$



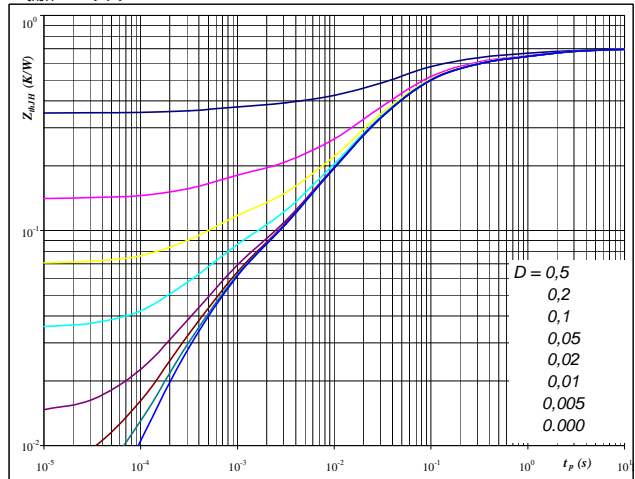
At
 $D = tp / T$
 $R_{thJH} = 0,451$ K/W $R_{thJH} = 0,54$ K/W
 Single device heated All devices heated
 IGBT thermal model values

R (K/W)	Tau (s)	R (K/W)	Tau (s)
0,05	3,0E+00	0,13	3,0E+00
0,08	4,5E-01	0,08	4,5E-01
0,19	7,6E-02	0,19	7,6E-02
0,09	1,7E-02	0,09	1,7E-02
0,02	1,7E-03	0,02	1,7E-03
0,02	2,9E-04	0,02	2,9E-04

Figure 20 Output inverter FWD

FWD transient thermal impedance as a function of pulse width

$Z_{thJH} = f(tp)$



At
 $D = tp / T$
 $R_{thJH} = 0,70$ K/W $R_{thJH} = 0,70$ K/W
 Single device heated All devices heated
 FWD thermal model values

R (K/W)	Tau (s)	R (K/W)	Tau (s)
0,02	9,9E+00	0,02	9,9E+00
0,08	1,4E+00	0,08	1,4E+00
0,17	1,6E-01	0,17	1,6E-01
0,31	3,6E-02	0,31	3,6E-02
0,08	7,1E-03	0,08	7,1E-03
0,05	5,3E-04	0,05	5,3E-04

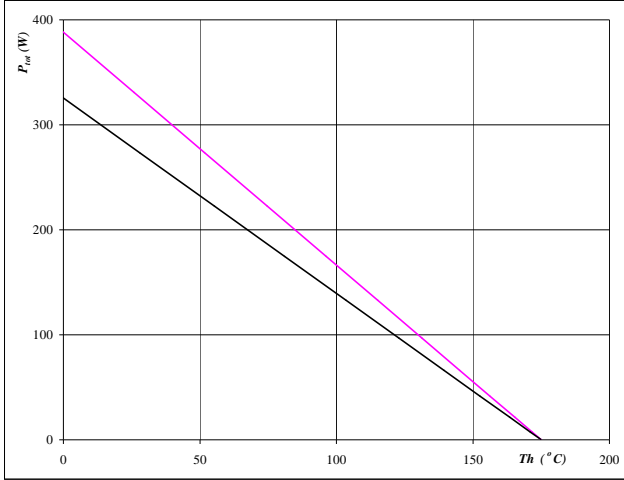


Output Inverter

Figure 21 Output inverter IGBT

Power dissipation as a function of heatsink temperature

$P_{tot} = f(T_h)$

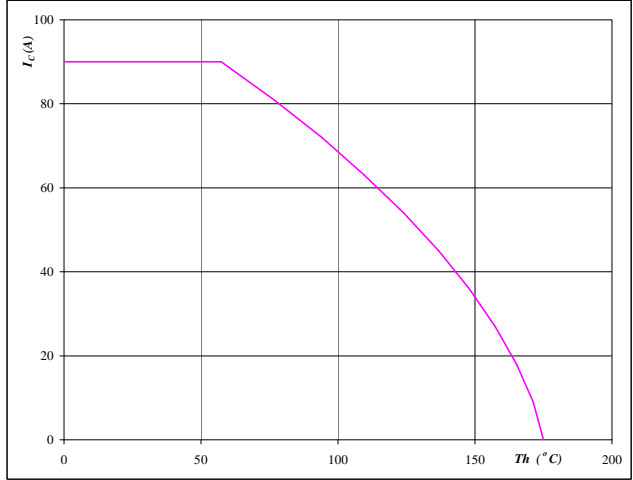


At
T_j = 175 °C
— single heating
— overall heating

Figure 22 Output inverter IGBT

Collector current as a function of heatsink temperature

$I_C = f(T_h)$

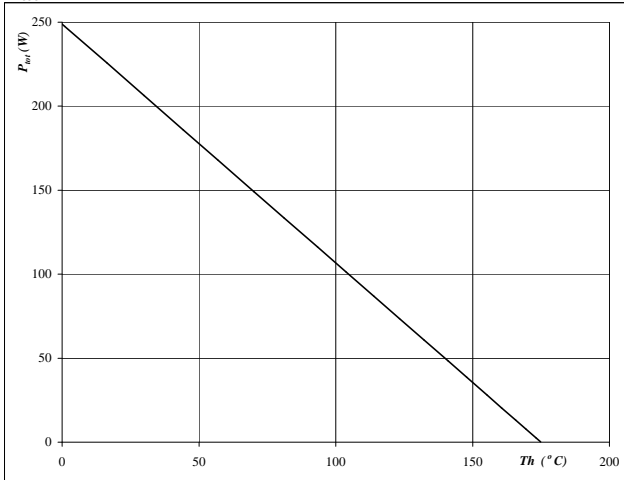


At
T_j = 175 °C
V_{GE} = 15 V

Figure 23 Output inverter FWD

Power dissipation as a function of heatsink temperature

$P_{tot} = f(T_h)$

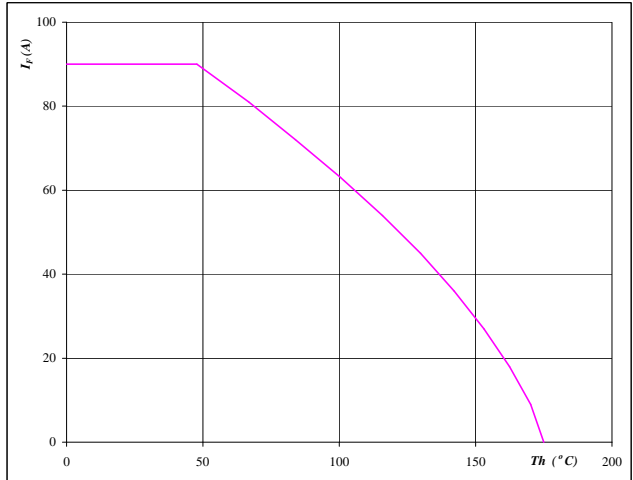


At
T_j = 175 °C

Figure 24 Output inverter FWD

Forward current as a function of heatsink temperature

$I_F = f(T_h)$



At
T_j = 175 °C

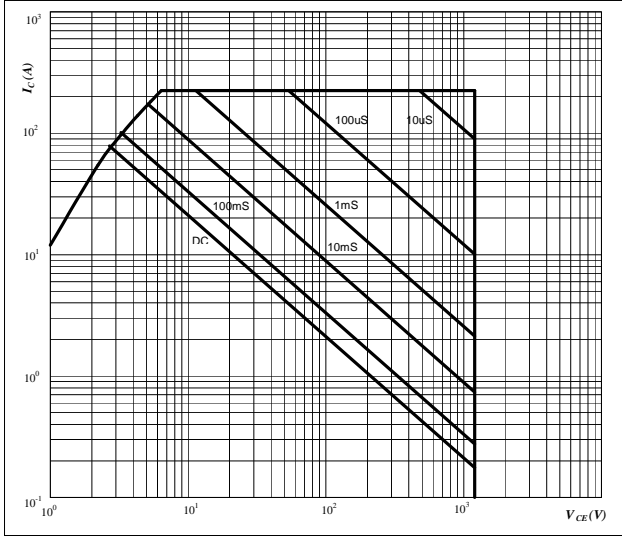


Output Inverter

Figure 25 Output inverter IGBT

Safe operating area as a function of collector-emitter voltage

$I_C = f(V_{CE})$

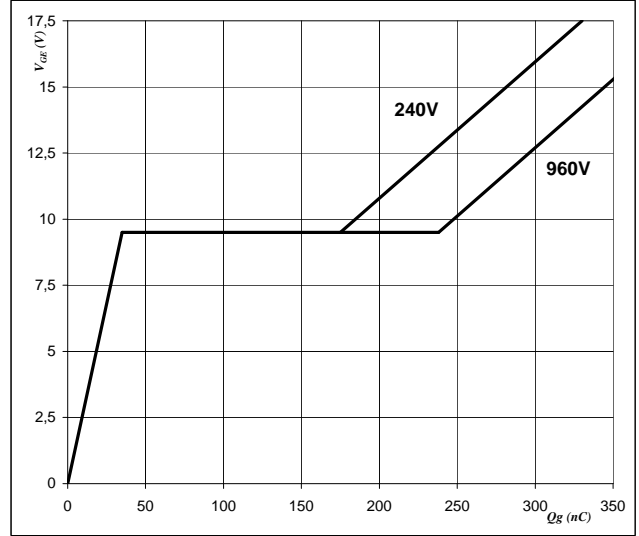


At
 D = single pulse
 Th = 80 °C
 V_{GE} = ±15 V
 Tj = T_{jmax} °C

Figure 26 Output inverter IGBT

Gate voltage vs Gate charge

$V_{GE} = f(Q_g)$



At
 I_C = 75 A

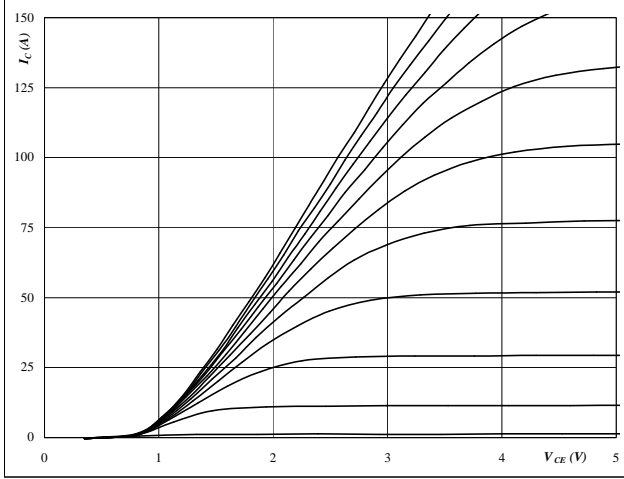


Brake

Figure 1 Brake IGBT

Typical output characteristics

$I_C = f(V_{CE})$

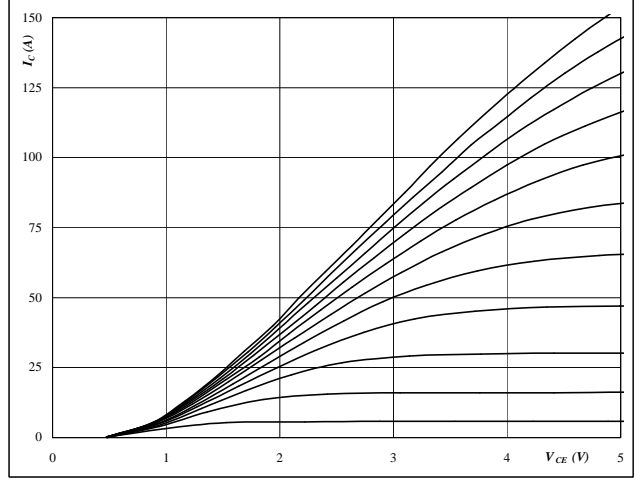


At
 $t_p = 250 \mu s$
 $T_j = 25 \text{ }^\circ C$
VGE from 7 V to 17 V in steps of 1 V

Figure 2 Brake IGBT

Typical output characteristics

$I_C = f(V_{CE})$

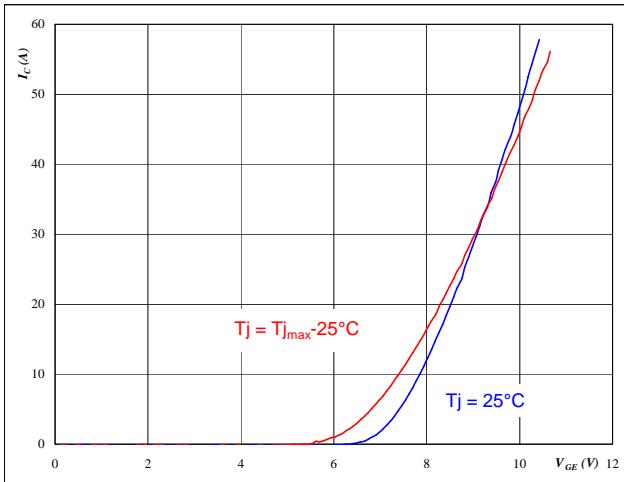


At
 $t_p = 250 \mu s$
 $T_j = 150 \text{ }^\circ C$
VGE from 7 V to 17 V in steps of 1 V

Figure 3 Brake IGBT

Typical transfer characteristics

$I_C = f(V_{GE})$

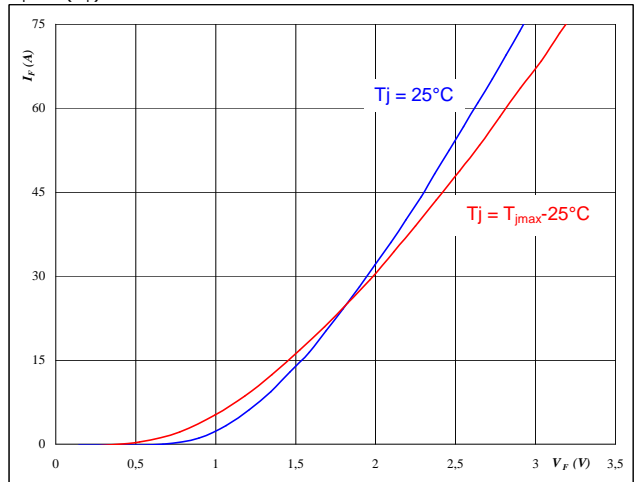


At
 $t_p = 250 \mu s$
 $V_{CE} = 10 V$

Figure 4 Brake FWD

Typical diode forward current as a function of forward voltage

$I_F = f(V_F)$



At
 $t_p = 250 \mu s$

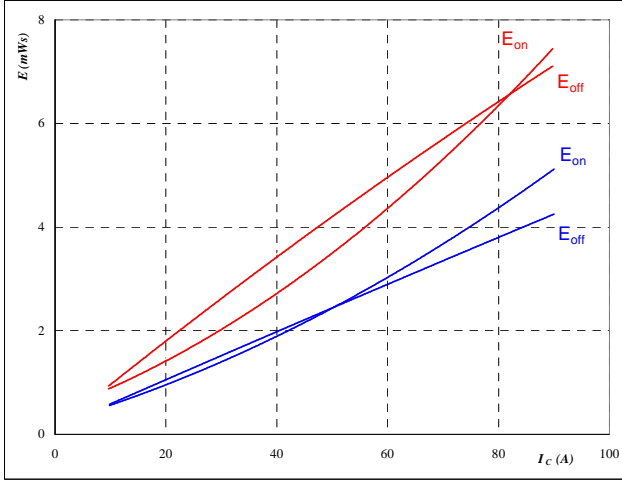


Brake

Figure 5 Brake IGBT

Typical switching energy losses as a function of collector current

$E = f(I_C)$



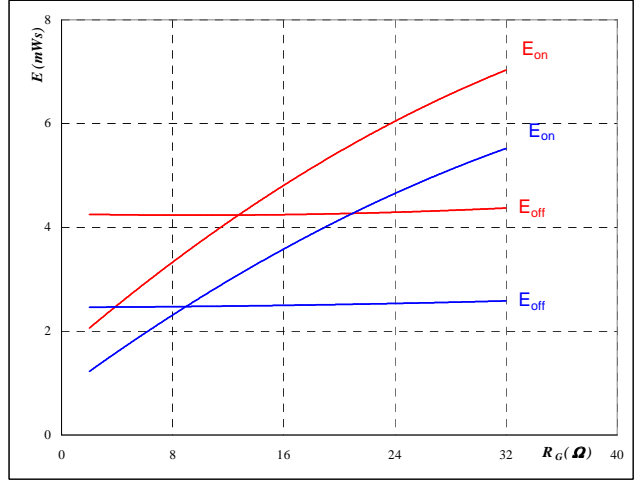
With an inductive load at

- T_j = 25/150 °C
- V_{CE} = 600 V
- V_{GE} = ±15 V
- R_{gon} = 8 Ω
- R_{goff} = 8 Ω

Figure 6 Brake IGBT

Typical switching energy losses as a function of gate resistor

$E = f(R_G)$



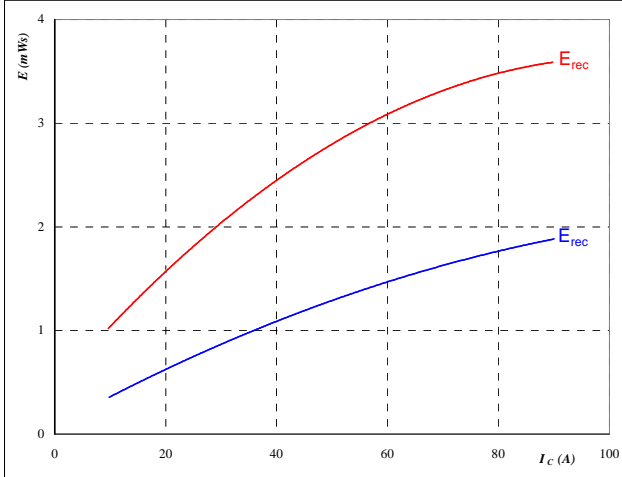
With an inductive load at

- T_j = 25/150 °C
- V_{CE} = 600 V
- V_{GE} = ±15 V
- I_C = 50 A

Figure 7 Brake IGBT

Typical reverse recovery energy loss as a function of collector current

$E_{rec} = f(I_C)$



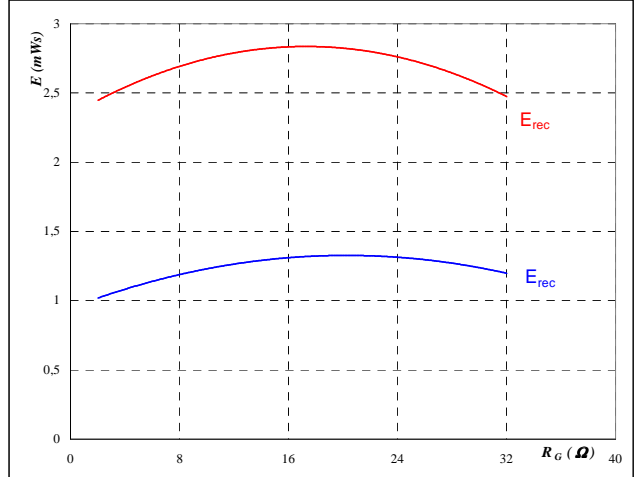
With an inductive load at

- T_j = 25/150 °C
- V_{CE} = 600 V
- V_{GE} = ±15 V
- R_{gon} = 8 Ω

Figure 8 Brake IGBT

Typical reverse recovery energy loss as a function of gate resistor

$E_{rec} = f(R_G)$



With an inductive load at

- T_j = 25/150 °C
- V_{CE} = 600 V
- V_{GE} = ±15 V
- I_C = 50 A

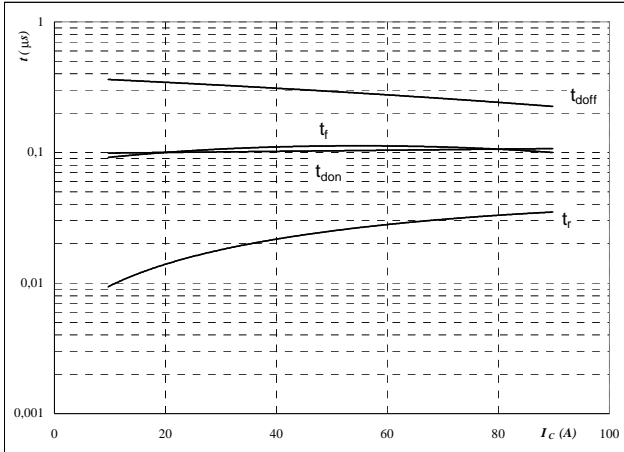


Brake

Figure 9 Brake IGBT

Typical switching times as a function of collector current

$t = f(I_C)$



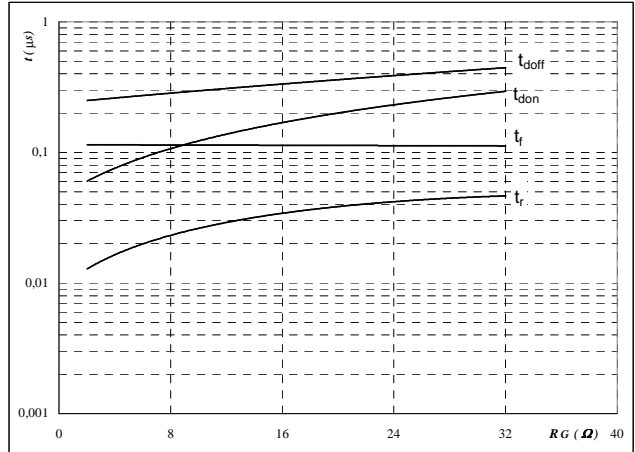
With an inductive load at

- $T_j = 150 \text{ } ^\circ\text{C}$
- $V_{CE} = 600 \text{ V}$
- $V_{GE} = \pm 15 \text{ V}$
- $R_{gon} = 8 \text{ } \Omega$
- $R_{goff} = 8 \text{ } \Omega$

Figure 10 Brake IGBT

Typical switching times as a function of gate resistor

$t = f(R_G)$



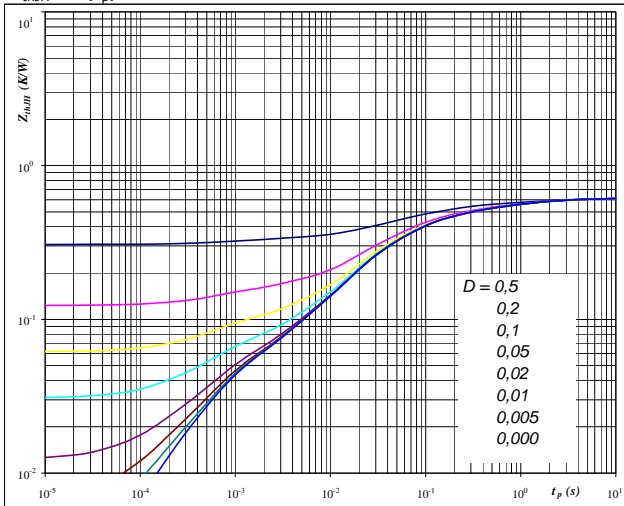
With an inductive load at

- $T_j = 150 \text{ } ^\circ\text{C}$
- $V_{CE} = 600 \text{ V}$
- $V_{GE} = \pm 15 \text{ V}$
- $I_C = 50 \text{ A}$

Figure 11 Brake IGBT

IGBT transient thermal impedance as a function of pulse width

$Z_{thJH} = f(t_p)$



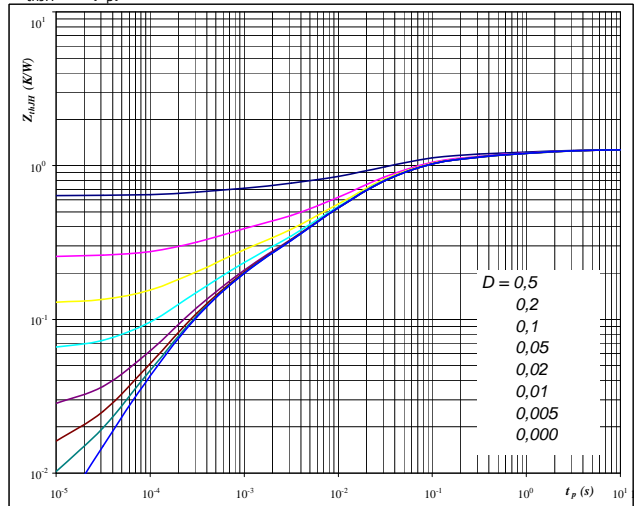
At

- $D = t_p / T$
- $R_{thJH} = 0,61 \text{ K/W}$

Figure 12 Brake IGBT

FWD transient thermal impedance as a function of pulse width

$Z_{thJH} = f(t_p)$



At

- $D = t_p / T$
- $R_{thJH} = 1,27 \text{ K/W}$

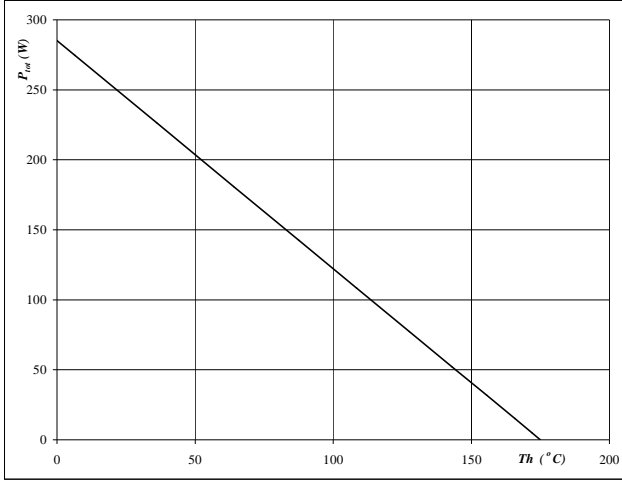


Brake

Figure 13 Brake IGBT

Power dissipation as a function of heatsink temperature

$P_{tot} = f(T_h)$

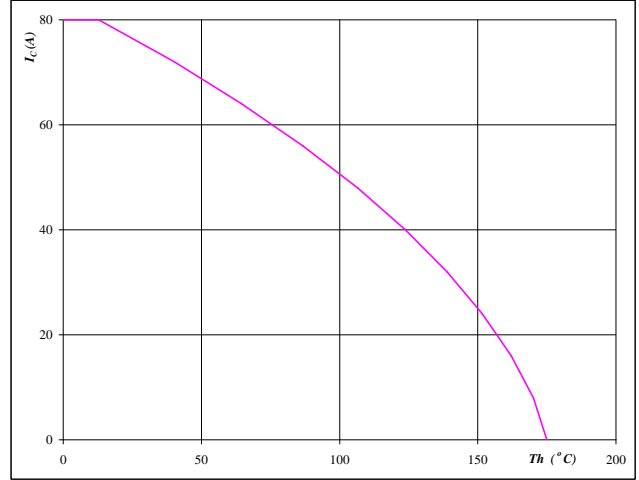


At
 $T_j = 175 \text{ } ^\circ\text{C}$

Figure 14 Brake IGBT

Collector current as a function of heatsink temperature

$I_C = f(T_h)$



At
 $T_j = 175 \text{ } ^\circ\text{C}$
 $V_{GE} = 15 \text{ V}$

Figure 15 Brake FWD

Power dissipation as a function of heatsink temperature

$P_{tot} = f(T_h)$

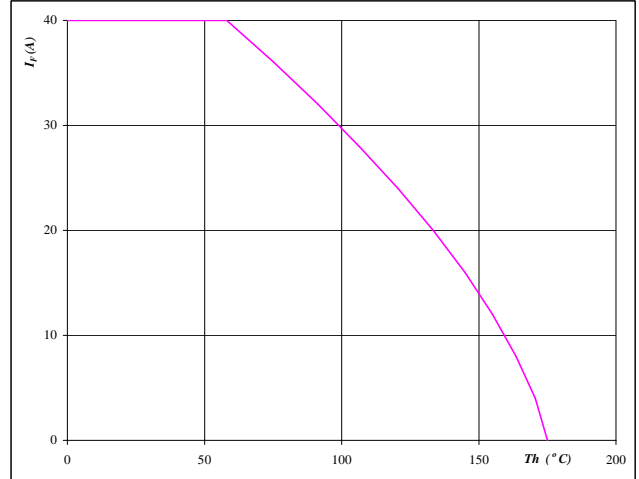


At
 $T_j = 175 \text{ } ^\circ\text{C}$

Figure 16 Brake FWD

Forward current as a function of heatsink temperature

$I_F = f(T_h)$



At
 $T_j = 175 \text{ } ^\circ\text{C}$

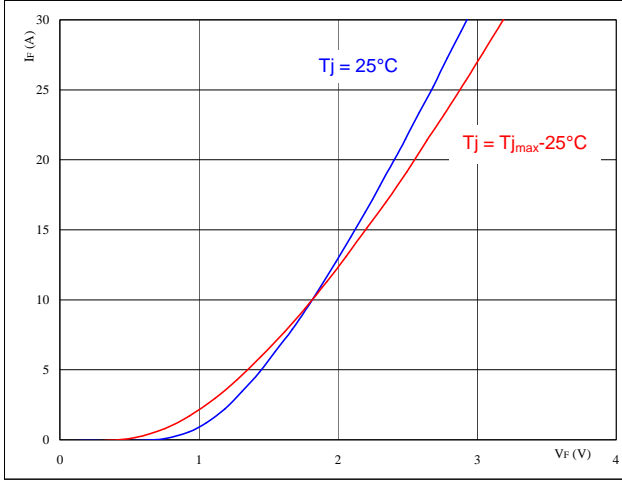


Brake Inverse Diode

Figure 1 Brake inverse diode

Typical diode forward current as a function of forward voltage

$I_F = f(V_F)$

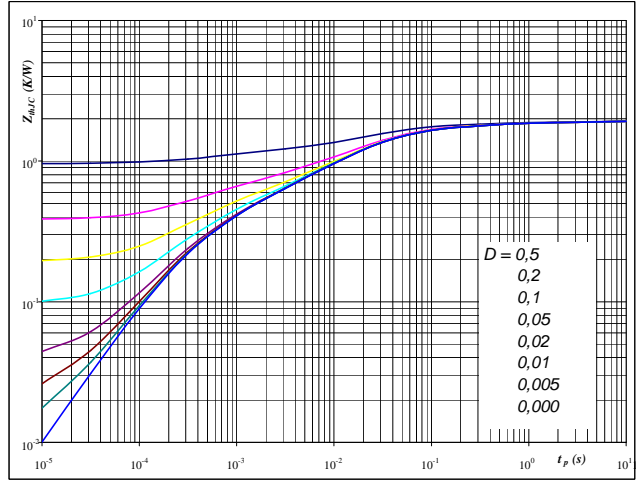


At
 $t_p = 250 \mu\text{s}$

Figure 2 Brake inverse diode

Diode transient thermal impedance as a function of pulse width

$Z_{\text{thJC}} = f(t_p)$

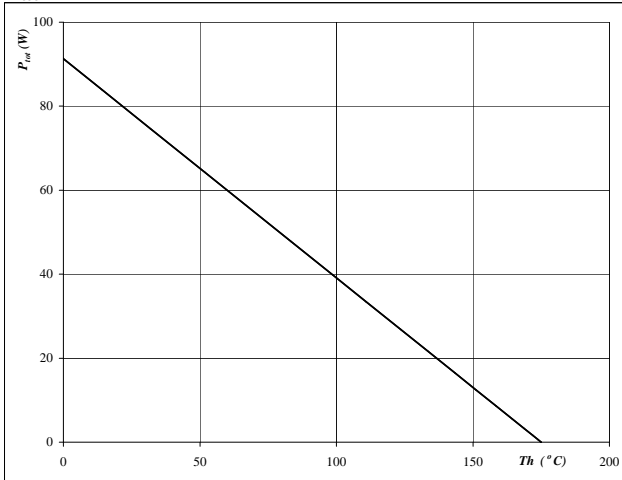


At
 $D = t_p / T$
 $R_{\text{thJH}} = 1,92 \text{ K/W}$

Figure 3 Brake inverse diode

Power dissipation as a function of heatsink temperature

$P_{\text{tot}} = f(T_h)$

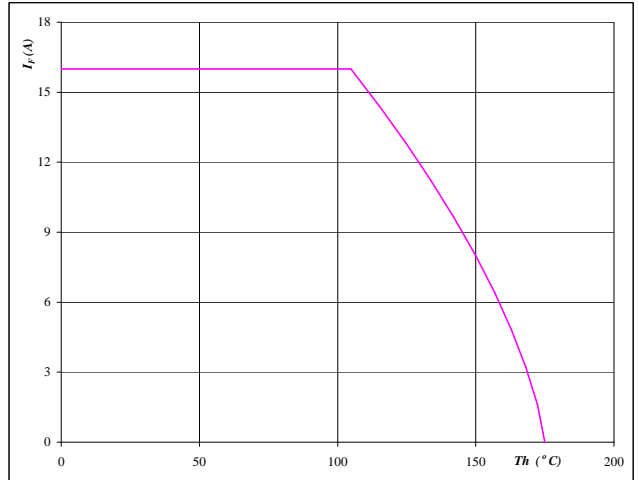


At
 $T_j = 175 \text{ }^\circ\text{C}$

Figure 4 Brake inverse diode

Forward current as a function of heatsink temperature

$I_F = f(T_h)$



At
 $T_j = 175 \text{ }^\circ\text{C}$

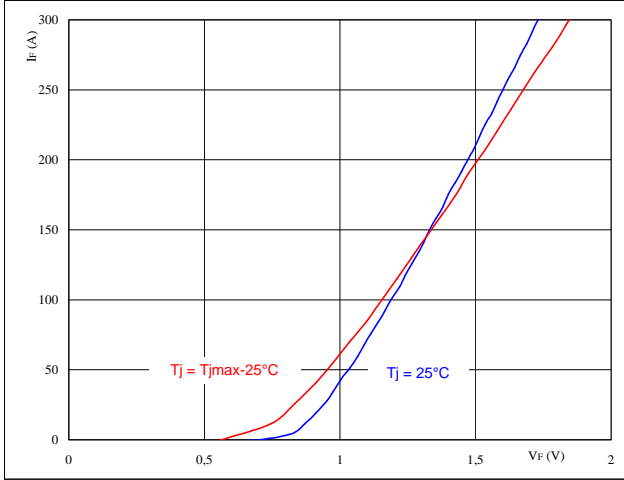


Input Rectifier Bridge

Figure 1 Rectifier diode

Typical diode forward current as a function of forward voltage

$I_F = f(V_F)$

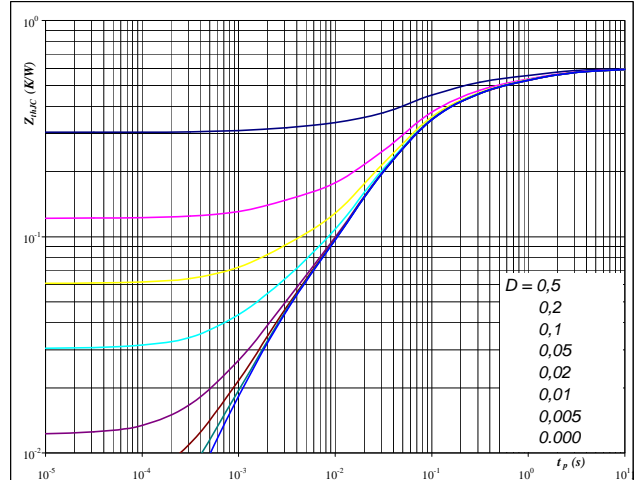


At
 $t_p = 250 \mu s$

Figure 2 Rectifier diode

Diode transient thermal impedance as a function of pulse width

$Z_{thJH} = f(t_p)$

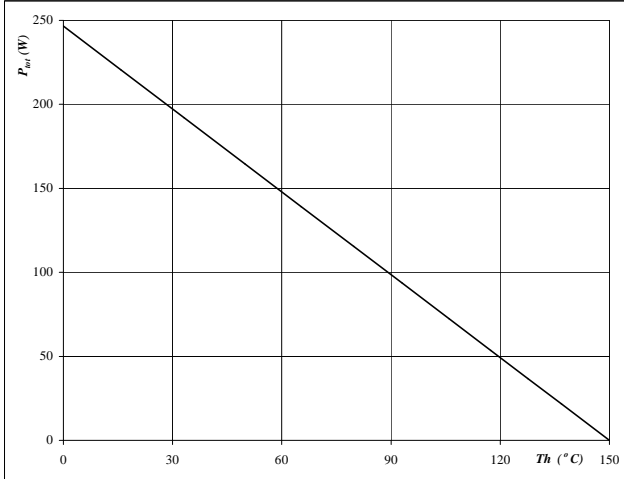


At
 $D = t_p / T$
 $R_{thJH} = 0,61 \text{ K/W}$

Figure 3 Rectifier diode

Power dissipation as a function of heatsink temperature

$P_{tot} = f(T_h)$

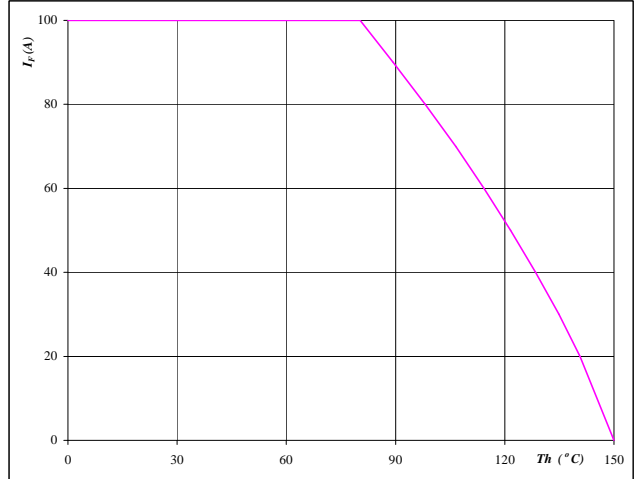


At
 $T_j = 150 \text{ °C}$

Figure 4 Rectifier diode

Forward current as a function of heatsink temperature

$I_F = f(T_h)$



At
 $T_j = 150 \text{ °C}$

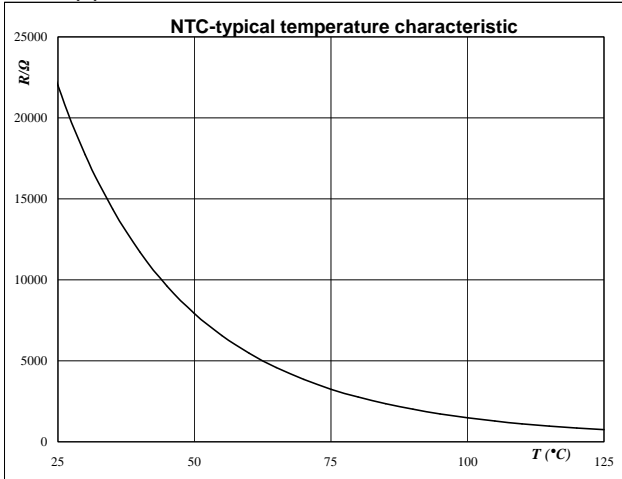


Thermistor

Figure 1 Thermistor

**Typical NTC characteristic
as a function of temperature**

$$R_T = f(T)$$





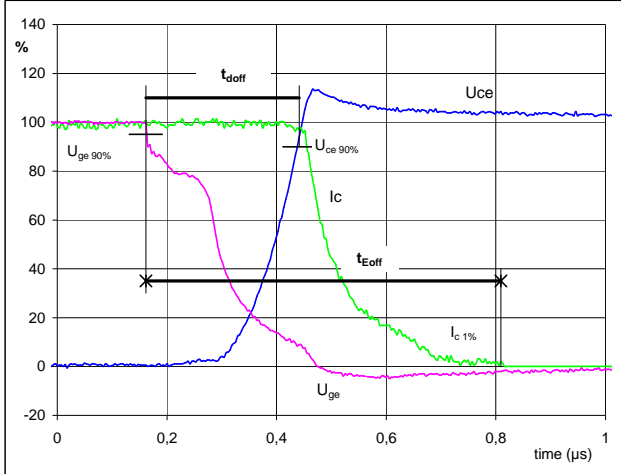
Switching Definitions Output Inverter

General conditions

T_j	=	150 °C
R_{gon}	=	8 Ω
R_{goff}	=	8 Ω

Figure 1 Output inverter IGBT

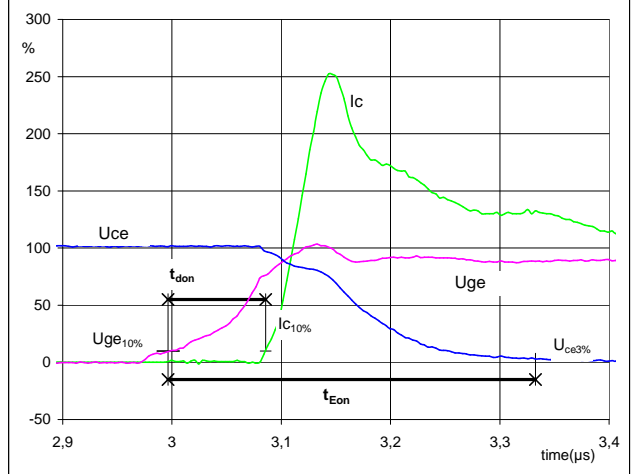
Turn-off Switching Waveforms & definition of t_{doff} t_{Eoff}
(t_{Eoff} = integrating time for E_{off})



$V_{GE} (0\%) =$	-15	V
$V_{GE} (100\%) =$	15	V
$V_C (100\%) =$	600	V
$I_C (100\%) =$	75	A
$t_{doff} =$	0,27	μs
$t_{Eoff} =$	0,65	μs

Figure 2 Output inverter IGBT

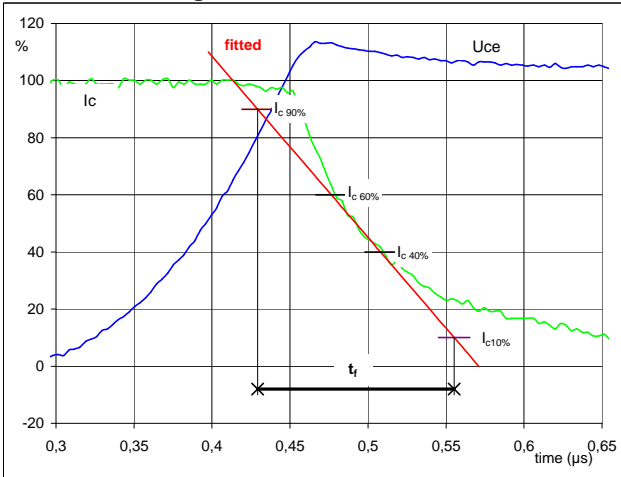
Turn-on Switching Waveforms & definition of t_{don} t_{Eon}
(t_{Eon} = integrating time for E_{on})



$V_{GE} (0\%) =$	-15	V
$V_{GE} (100\%) =$	15	V
$V_C (100\%) =$	600	V
$I_C (100\%) =$	75	A
$t_{don} =$	0,09	μs
$t_{Eon} =$	0,34	μs

Figure 3 Output inverter IGBT

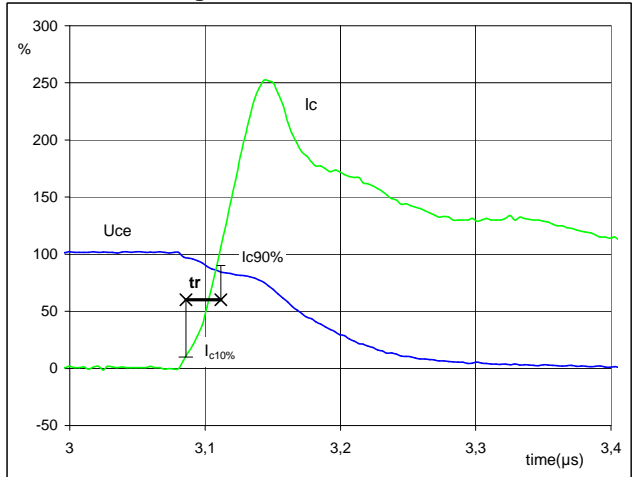
Turn-off Switching Waveforms & definition of t_f



$V_C (100\%) =$	600	V
$I_C (100\%) =$	75	A
$t_f =$	0,11	μs

Figure 4 Output inverter IGBT

Turn-on Switching Waveforms & definition of t_r

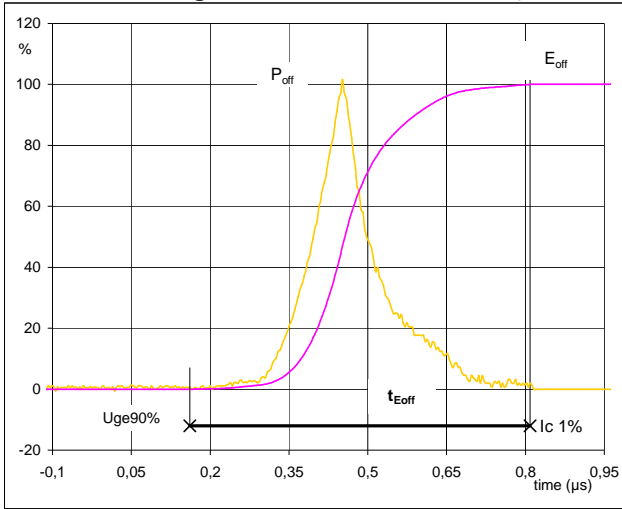


$V_C (100\%) =$	600	V
$I_C (100\%) =$	75	A
$t_r =$	0,02	μs



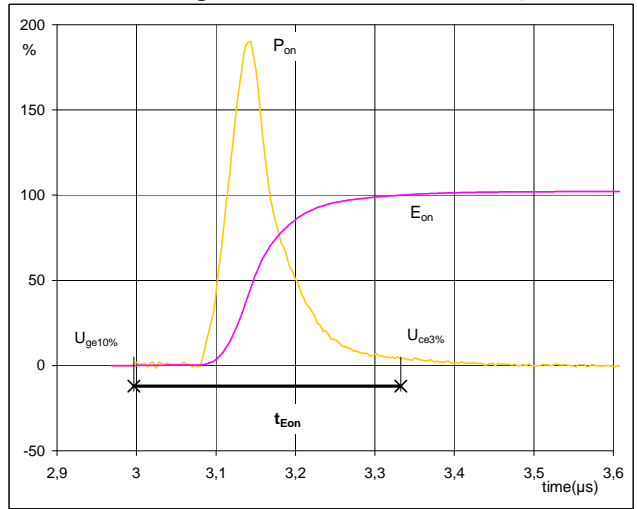
Switching Definitions Output Inverter

Figure 5 Output inverter IGBT
Turn-off Switching Waveforms & definition of t_{Eoff}



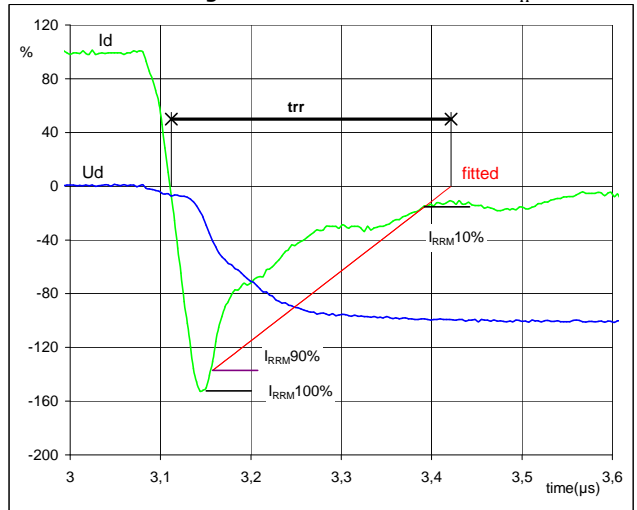
$P_{off} (100\%) = 45,16 \text{ kW}$
 $E_{off} (100\%) = 6,39 \text{ mJ}$
 $t_{Eoff} = 0,65 \text{ μs}$

Figure 6 Output inverter IGBT
Turn-on Switching Waveforms & definition of t_{Eon}



$P_{on} (100\%) = 45,16 \text{ kW}$
 $E_{on} (100\%) = 6,39 \text{ mJ}$
 $t_{Eon} = 0,34 \text{ μs}$

Figure 7 Output inverter FWD
Turn-off Switching Waveforms & definition of t_{rr}

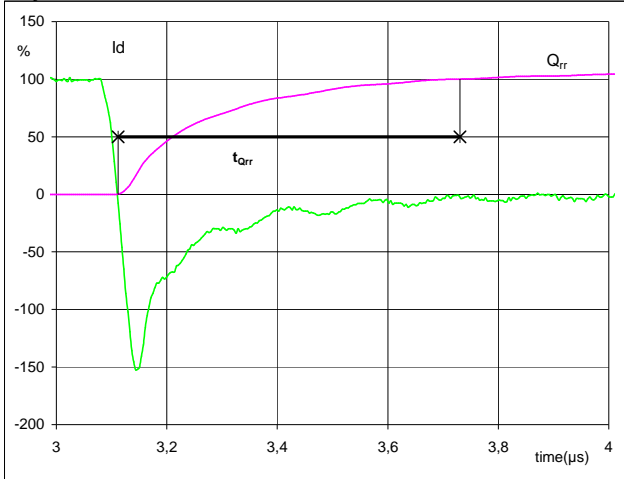


$V_d (100\%) = 600 \text{ V}$
 $I_d (100\%) = 75 \text{ A}$
 $I_{RRM} (100\%) = -117 \text{ A}$
 $t_{rr} = 0,31 \text{ μs}$



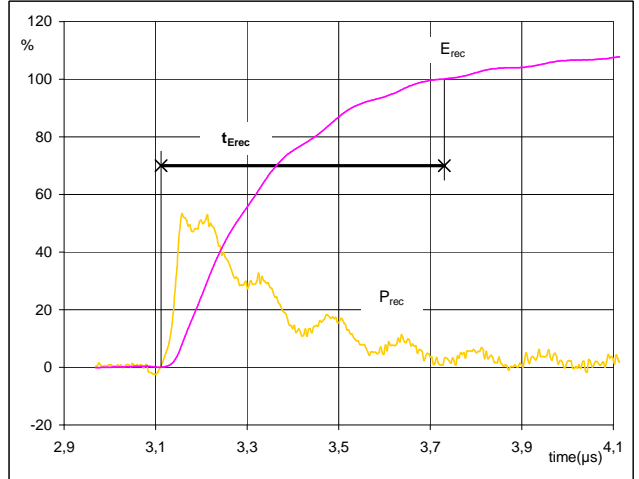
Switching Definitions Output Inverter

Figure 8 Output inverter FWD
Turn-on Switching Waveforms & definition of t_{Qrr}
(t_{Qrr} = integrating time for Q_{rr})



I_d (100%) = 75 A
 Q_{rr} (100%) = 14,13 μ C
 t_{Qint} = 0,62 μ s

Figure 9 Output inverter FWD
Turn-on Switching Waveforms & definition of t_{Erec}
(t_{Erec} = integrating time for E_{rec})



P_{rec} (100%) = 45,16 kW
 E_{rec} (100%) = 5,64 mJ
 t_{Erec} = 0,62 μ s

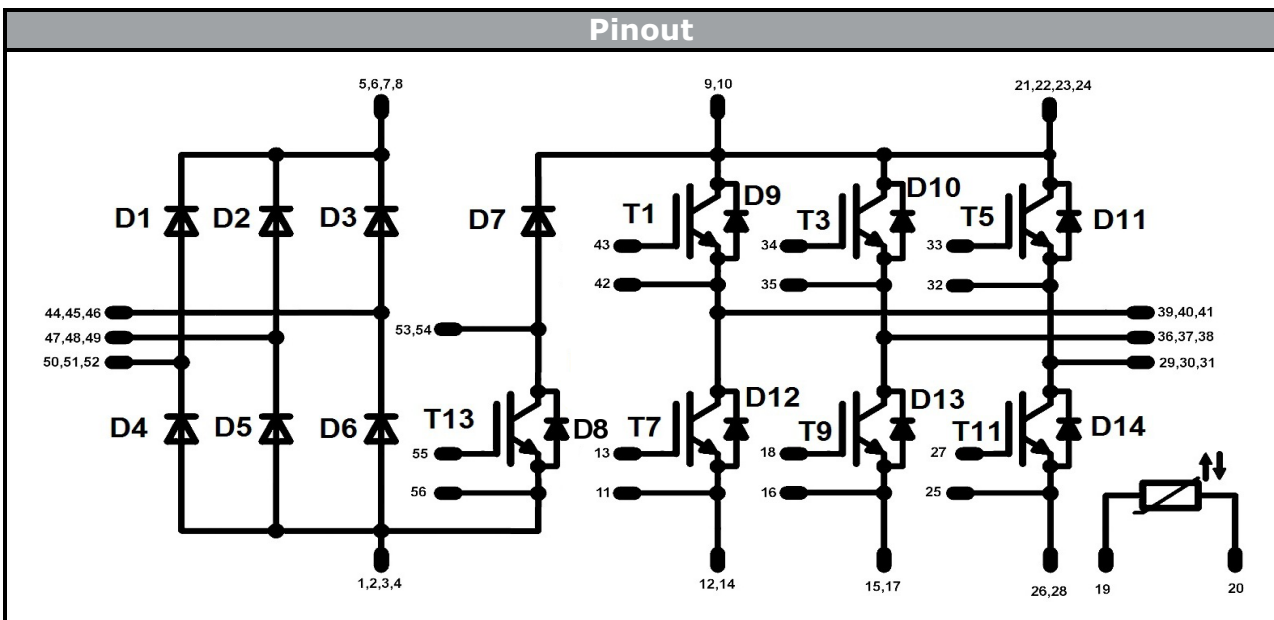


Ordering Code and Marking - Outline - Pinout

Ordering Code & Marking			
Version	Ordering Code	in DataMatrix as	in packaging barcode as
without thermal paste with solder pins	V23990-P769-A-PM	P769A	P769A
without thermal paste with Press-fit pins	V23990-P769-AY-PM	P769AY	P769AY
with thermal paste with solder pins	V23990-P769-A-/3/-PM	P769A	P769A-/3/
with thermal paste with Press-fit pins	V23990-P769-AY-/3/-PM	P769AY	P769AY-/3/

Outline

Pin table							
Pin		X	Y	Pin	X	Y	
1	DC-	71,2	0	29	U	0	37,2
2	DC-	68,7	0	30	U	2,5	37,2
3	DC-	66,2	0	31	U	5	37,2
4	DC-	63,7	0	32	E	7,8	37,2
5	DC+	55,95	0	33	G	10,6	37,2
6	DC+	53,45	0	34	G	18,45	37,2
7	DC+	55,95	2,8	35	E	21,25	37,2
8	DC+	53,45	2,8	36	V	24,05	37,2
9	DC+	48,4	0	37	V	26,55	37,2
10	DC+	45,9	0	38	V	29,05	37,2
11	E	38,9	0	39	W	36,1	37,2
12	DC-	36,1	0	40	W	38,6	37,2
13	G	38,9	2,8	41	W	41,1	37,2
14	DC-	36,1	2,8	42	E	43,9	37,2
15	DC-	31,3	0	43	G	46,7	37,2
16	E	28,5	0	44	L1	53,7	37,2
17	DC-	31,3	2,8	45	L1	56,2	37,2
18	G	28,5	2,8	46	L1	58,7	37,2
19	R1	19,3	0	47	L2	71,2	37,2
20	R2	19,3	2,8	48	L2	71,2	34,7
21	DC+	12,3	0	49	L2	71,2	32,2
22	DC+	9,8	0	50	L3	71,2	25,2
23	DC+	12,3	2,8	51	L3	71,2	22,7
24	DC+	9,8	2,8	52	L3	71,2	20,2
25	E	2,8	0	53	BrC	71,2	12,8
26	DC-	0	0	54	BrC	68,7	12,8
27	G	2,8	2,8	55	BrG	71,2	5,6
28	DC-	0	2,8	56	BrE	71,2	2,8



Identification

ID	Component	Voltage	Current	Function	Comment
T1,T3,T5,T7,T9, T11	IGBT	1200V	70A	Inverter Switch	
D9,D10,D11, D12,D13,D14	FWD	1200V	75A	Inverter Diode	
T13	IGBT	1200V	50A	Brake Switch	
D7	FWD	1200V	25A	Brake Diode	
D8	FWD	1200V	10A	Brake Protection Diode	
D1,D2,D3,D4,D5,D6	Rectifier	1600V	75A	Rectifier	
NTC	NTC	-	-	Thermistor	

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